To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

MOS FIELD EFFECT TRANSISTOR

2SK2070

N-CHANNEL MOS FET
FOR HIGH-SPEED SWITCHING

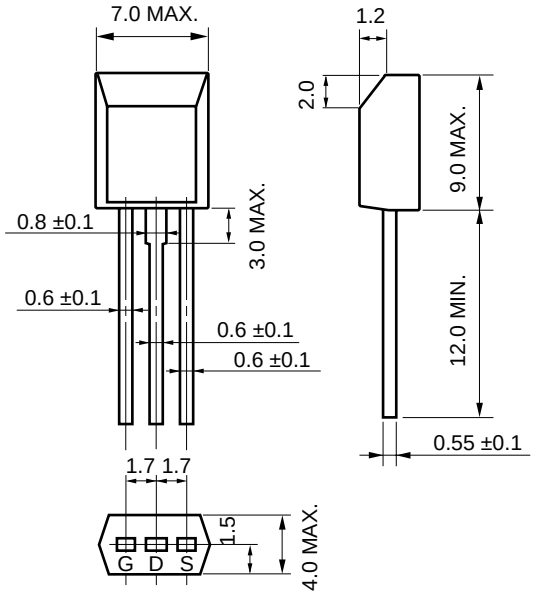
The 2SK2070 is a N-channel MOS FET of a vertical type and is a switching element that can be directly driven by the output of an IC operating at 5 V.

This product has a low ON resistance and superb switching characteristics and is ideal for driving the actuators, such as motors and DC/DC converters.

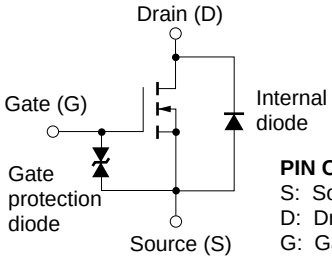
FEATURES

- New package intermediate between small-signal and power models
- Can be directly driven by output of 5-V IC
- Low ON resistance
  $R_{DS(on)}$ = 0.45 Ω MAX. @V_{GS} = 4 V, I_D = 1.0 A
  $R_{DS(on)}$ = 0.35 Ω MAX. @V_{GS} = 10 V, I_D = 1.0 A

PACKAGE DIMENSIONS (in mm)



EQUIVALENT CIRCUIT



PIN CONNECTIONS
S: Source
D: Drain
G: Gate

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C)

PARAMETER	SYMBOL	TEST CONDITIONS	RATING	UNIT
Drain to Source Voltage	V_{DSS}	V_{GS} = 0	100	V
Gate to Source Voltage	V_{GSS}	V_{DS} = 0	±20	V
Drain Current (DC)	$I_{D(DC)}$		±1.5	A
Drain Current (Pulse)	$I_{D(pulse)}$	PW ≤ 10 ms, Duty cycle ≤ 50 %	±3.0	A
Total Power Dissipation	P_T		1.0	W
Channel Temperature	T_{ch}		150	°C
Storage Temperature	T_{stg}		–55 to +150	°C

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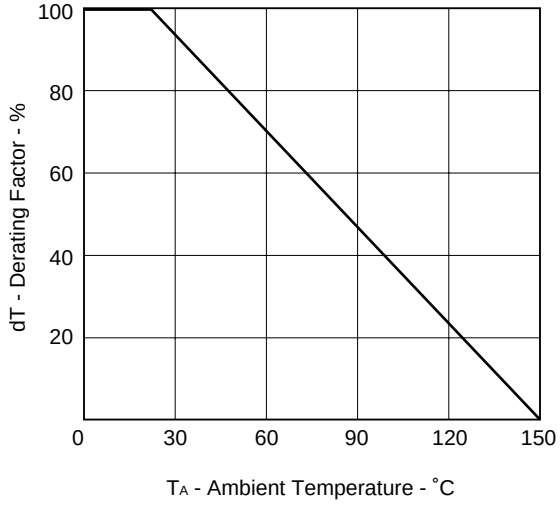
Printed in Japan

ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

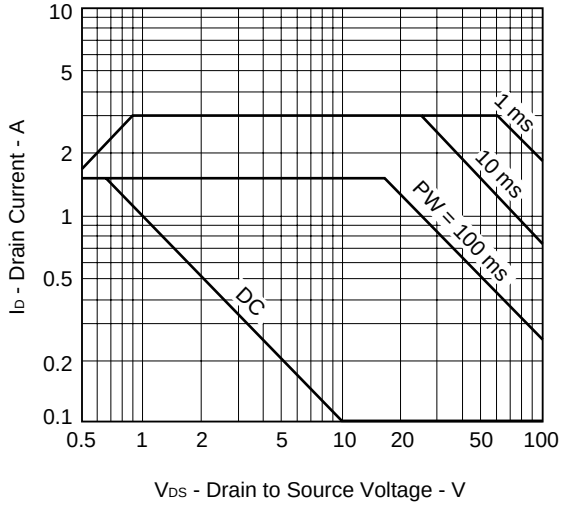
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-Off Current	I_{DSS}	V_{DS} = 100 V, V_{GS} = 0			1.0	μA
Gate Leakage Current	I_{GSS}	V_{GS} = ±20 V, V_{DS} = 0			±10	μA
Gate Cut-Off Voltage	$V_{GS(off)}$	V_{DS} = 10 V, I_D = 1 mA	0.8	1.2	2.0	V
Forward Transfer Admittance	$\|y_{fs}\|$	V_{DS} = 10 V, I_D = 1.0 A	2.0			S
Drain to Source On-State Resistance	$R_{DS(on)1}$	V_{GS} = 4 V, I_D = 1.0 A		0.28	0.45	Ω
Drain to Source On-State Resistance	$R_{DS(on)2}$	V_{GS} = 10 V, I_D = 1.0 A		0.24	0.35	Ω
Input Capacitance	C_{iss}	V_{DS} = 10 V, V_{GS} = 0, f = 1.0 MHz		530		pF
Output Capacitance	C_{oss}			150		pF
Reverse Transfer Capacitance	C_{rss}			30		pF
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 10 V, I_D = 1.0 A, $V_{GS(on)}$ = 10 V, R_G = 10 Ω, R_L = 10 Ω		5		ns
Rise Time	t_r			50		ns
Turn-Off Delay Time	$t_{d(off)}$			90		ns
Fall Time	t_f			15		ns

TYPICAL CHARACTERISTICS (T_A = 25 ˚C)

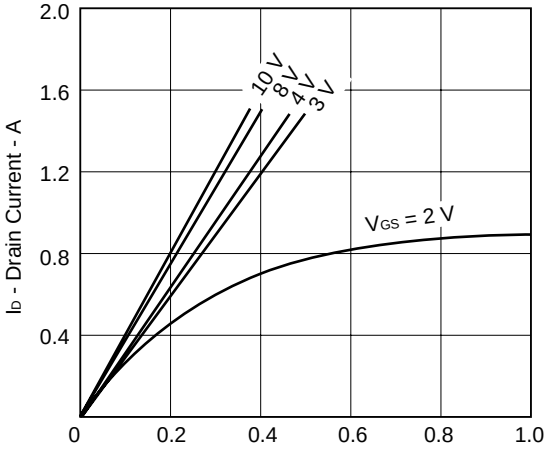
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



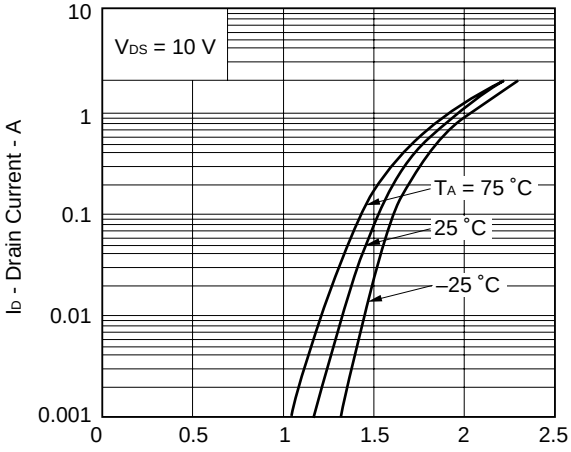
FORWARD BIAS SAFE OPERATING AREA



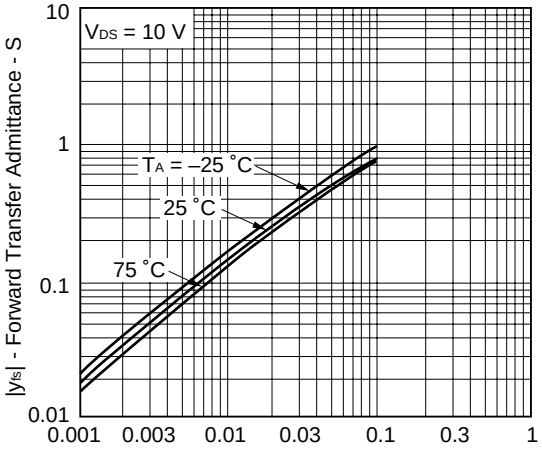
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



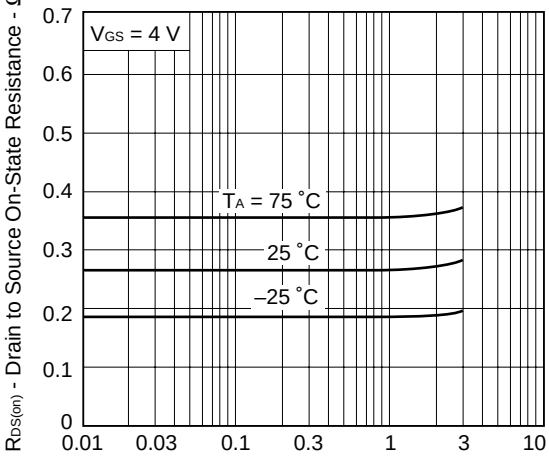
TRANSFER CHARACTERISTICS



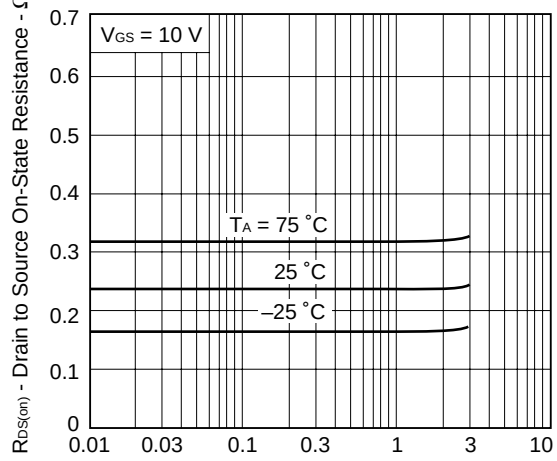
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

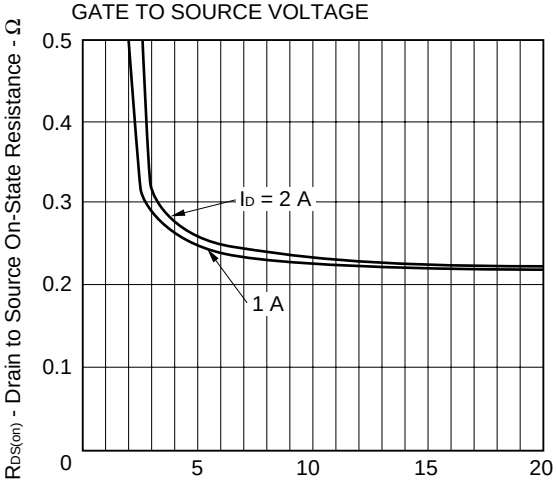


DRAIN TO SOURCE ON-STATE RESISTANCE vs.
DRAIN CURRENT



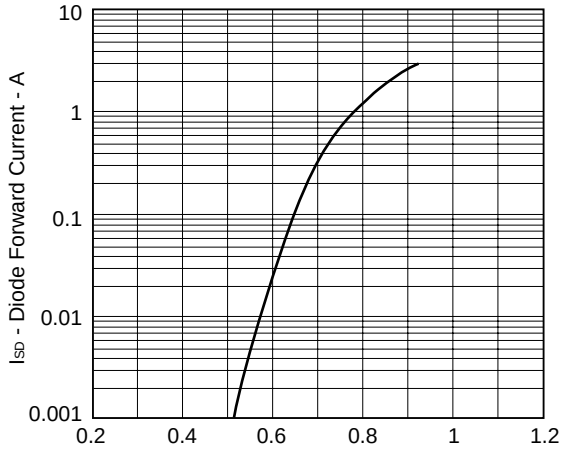
ID - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE



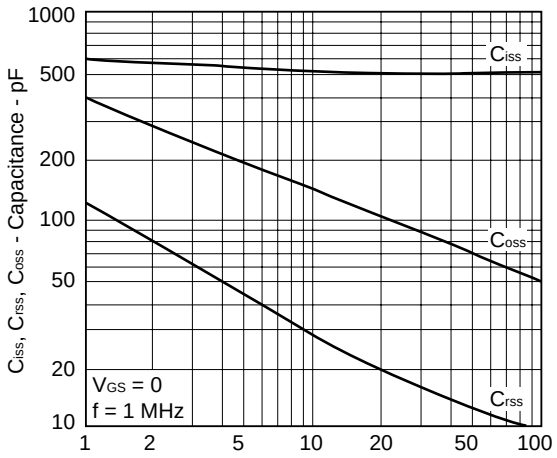
VGS - Gate to Source Voltage - V

SOURCE TO DRAIN DIODE
FORWARD VOLTAGE



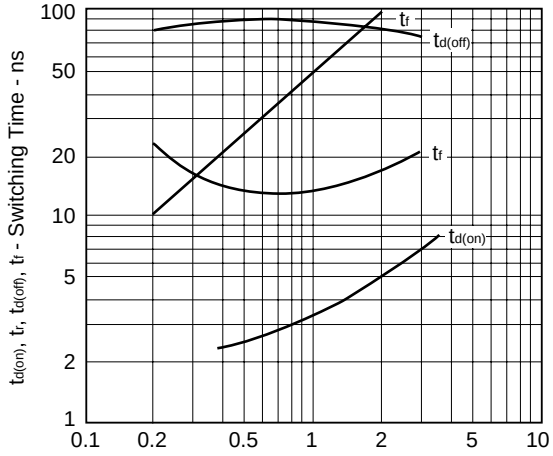
VSD - Source to Drain Voltage - V

CAPACITANCE vs.
DRAIN TO SOURCE VOLTAGE



VDS - Drain to Source Voltage - V

SWITCHING CHARACTERISTICS



ID - Drain Current - A

REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	C10535E
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	X10679E

[MEMO]